

Features

- High reliability LED package.
- Ideal for indication light on hand held products
- Long life and robust package
- Standard Package: 500pcs/ Reel
- MSL (Moisture Sensitivity Level): 2a
- Halogen-free
- RoHS compliant

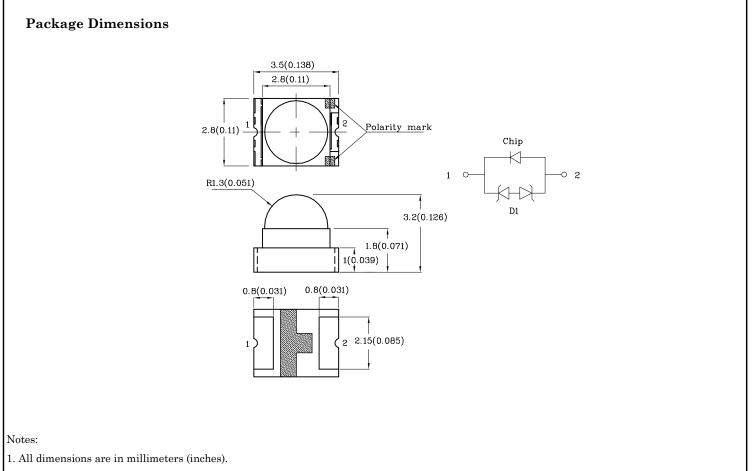




ATTENTION OBSERVE PRECAUTIONS FOR HANDLING ELECTROSTATIC DISCHARGE SENSITIVE DEVICES

Applications

- Backlighting for tell-tale indicators
- Dashboard lighting
- Interior lighting (footwell, dome light, accent lighting, etc.)
- Exterior lighting (turn signals, side markers, CHMSL, etc.)
- Signs and signals
- Various applications requiring high temperature rating



- 2. Tolerance is $\pm 0.2(0.008")$ unless otherwise noted.
- 3. Specifications are subject to change without notice.



Part Number: XZM2ACRZ45W-2HTA

3.5 x2.8mm High Temperature Series

Part Number	Emitting Color	Emitting Material	Lens-color	Luminous Intensity CIE127-2007* (IF=20mA) mcd		Viewing Angle 20 1/2		
				Code.	Min.	Max.		
	Red A	AlGaInP	- - Water Clear -	ZB	3600	4200		
XZM2ACRZ45W-2HTA				ZC	4200	5000		
				ZD	5000	6000		
				ZE	6000	7000	709	
		AlGaInP		U*	1000*	1300*	70°	
				V*	1300*	1600*		
					W*	1600*	1900*	
			-	X*	1900*	2300*		

Note:

1.01/2 is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value.

*Luminous intensity value is in accordance with ${\rm CIE127}\mathchar`-2007$ standards.

Absolute Maximum Ratings at Ta=25°C

Parameter	Symbol	Value	Unit
Power dissipation	Pd	84	mW
Junction temperature	$T_{\rm J}$	115	°C
Reverse Voltage	VR	5	V
Operating Temperature	Тор	-40 To +100	°C
Storage Temperature	Tstg	-40 To +115	°C
DC Forward Current	IF	30	mA
Peak Forward Current [2]	IFM	150	mA
Electrostatic Discharge Threshold (HBM)		8000	V
Thermal Resistance (Junction/ambient) [1]	Rth j-a	540	°C/W
Thermal Resistance (Junction / Solder point) [1]	$\operatorname{Rth} j\text{-}s$	430	°C/W

Notes:

1. Rth(j-a) Results from mounting on PC board FR4 (pad size≥16 mm² per pad),

2. 1/10 Duty Cycle, 0.1ms Pulse Width.

3. A Relative Humidity between 40% and 60% is recommended in ESD-protected work areas to reduce static build up during assembly process (Reference JEDEC/JESD625-A and JEDEC/J-STD-033)

Electrical / Optical Characteristics at Ta=25°C

D. (S 1 1	Value			TT •/	
Parameter	Symbol	Min.	Тур.	Max.	Unit	
Wavelength at peak emission CIE127-2007* IF = 20 mA	λ peak	-	640*		nm	
Dominant Wavelength CIE127-2007* IF = 20mA	λ dom [1]	610*	-	635*	nm	
Spectral bandwidth at 50% $F_{REL MAX}$ IF = 20mA	Δλ	-	25		nm	
Forward Voltage IF = 20mA	Vf [2]	-	2.2	2.8	V	
Reverse Current $V_R = 5V$	Ir	-	-	10	μA	
Temperature coefficient of λ peak IF = 20mA,-10°C \leq T \leq 100°C	TC λ peak	-	0.13	-	nm/°C	
Temperature coefficient of λdom IF = 20mA,-10°C $\leq T \leq 100$ °C	TC λ dom	-	0.06	-	nm/°C	
$\label{eq:linear} \begin{array}{l} Temperature \ coefficient \ of \ VF \\ IF = 20mA, -10^{\circ}C \leq T \leq 100^{\circ}C \end{array}$	TCv	-	-2.0	-	mV/°C	

Notes:

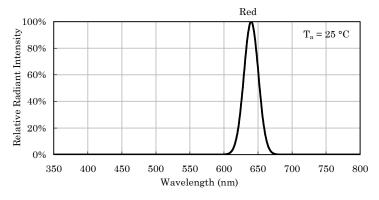
1. Wavelength : + / -1nm.

2. Forward Voltage: +/-0.1V.

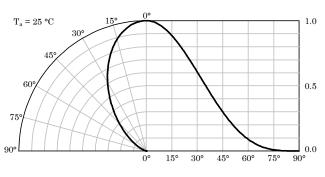
* Wavelength value is in accordance with CIE127-2007 standards. Dec 13,2019



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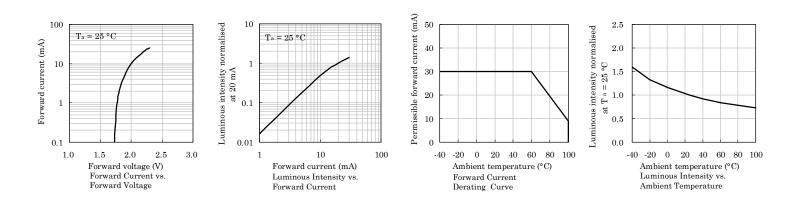


Relative Intensity Vs. CIE Wavelength

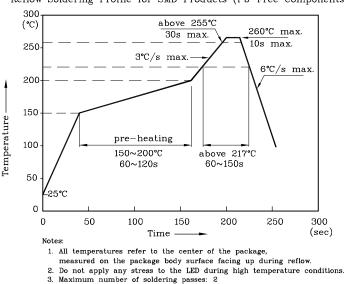


Spatial Distribution

✤ Red



LED is recommended for reflow soldering and soldering profile is shown below.

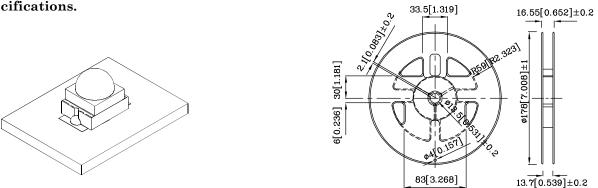


Reflow Soldering Profile for SMD Products (Pb-Free Components)

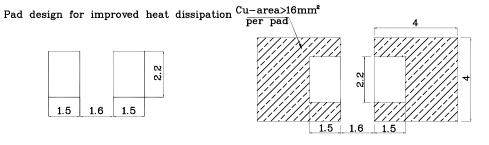


The device has a single mounting surface. The device must be mounted according to the specifications.

Reel Dimension

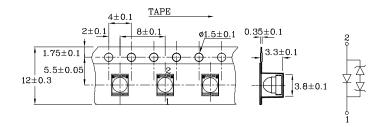


Recommended Soldering Pattern (Units : mm; Tolerance: ±0.1)



💹 Solder resist

Tape Specification (Units : mm)



Remarks:

If special sorting is required (e.g. binning based on forward voltage, Luminous intensity / luminous flux, or wavelength),

the typical accuracy of the sorting process is as follows:

1. Wavelength: +/-1nm

2. Luminous intensity / luminous flux: +/-15%

3. Forward Voltage: +/-0.1V

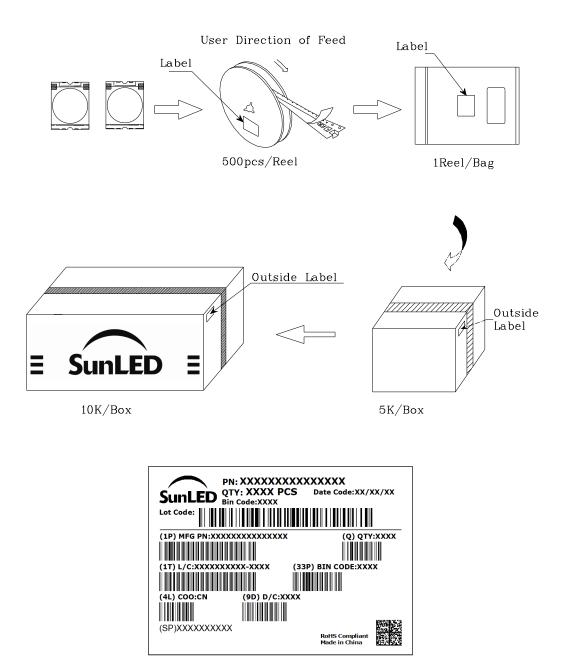
Note: Accuracy may depend on the sorting parameters.

Dec 13,2019



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PACKING & LABEL SPECIFICATIONS



TERMS OF USE

- 1. Data presented in this document reflect statistical figures and should be treated as technical reference only.
- 2. Contents within this document are subject to improvement and enhancement changes without notice.
- 3. The product(s) in this document are designed to be operated within the electrical and environmental specifications indicated on the datasheet. User accepts full risk and responsibility when operating the product(s) beyond their intended specifications.
- 4. The product(s) described in this document are intended for electronic applications in which a person's life is not reliant upon the LED. Please
 - $consult \ with \ a \ SunLED \ representative \ for \ special \ applications \ where \ the \ LED \ may \ have \ a \ direct \ impact \ on \ a \ person's \ life.$
- 5. The contents within this document may not be altered without prior consent by SunLED.
- $6. \ Additional \ technical \ notes \ are \ available \ at \ \underline{https://www.SunLEDusa.com/TechnicalNotes.asp}$

Dec 13,2019

XDSB9291 V2-X Layout: Maggie L



Reliability Test Items And Conditions

The reliability of products shall be satisfied with items listed below Lot Tolerance Percent Defective (LTPD): 10%

No.	Test Item	Standards	Test Condition	Test Times / Cycles	Number of Damaged
1	Continuous operating test	-	$T_a = 25^{\circ}C$, $I_F =$ maximum rated current *	1,000 h	0 / 22
2	High Temp. operating test	EIAJ ED-4701/100 (101)	T_a = 100°C, I_F = maximum rated current *	1,000 h	0 / 22
3	Low Temp. operating test	-	T_a = -40°C, I _F = maximum rated current *	1,000 h	0 / 22
4	High temp. storage test	EIAJ ED-4701/100 (201)	T _a = maximum rated storage temperature	1,000 h	0 / 22
5	Low temp. storage test	EIAJ ED-4701/100 (202)	$T_a = -40^{\circ}C$	1,000 h	0 / 22
6	High temp. & humidity storage test	EIAJ ED-4701/100 (103)	$T_a = 60$ °C, RH = 90%	1,000 h	0 / 22
7	High temp. & humidity operating test	EIAJ ED-4701/100 (102)	$T_a = 60^{\circ}C, RH = 90\%$ I _F = maximum rated current *	1,000 h	0 / 22
8	Soldering reliability test	EIAJ ED-4701/100 (301)	Moisture soak: 30°C, 70% RH, 72h Preheat: 150~180°C (120s max.) Soldering temp: 260°C(10s)	2 times	0 / 18
9	Thermal shock operating test	-	$T_a = -40^{\circ}C(15min) \sim 100^{\circ}C(15min)$ I _F = derated current at 100°C	1,000 cycles	0 / 22
10	Thermal shock test	-	T _a = -40°C(15min) ~ maximum rated Storage temperature(15min)	1,000 cycles	0 / 22
11	Electric Static Discharge (ESD)	EIAJ ED-4701/100 (304)	$\mathrm{C}=100\mathrm{pF}$, $\mathrm{R2}=1.5\mathrm{K}\Omega$ $\mathrm{V}=8000\mathrm{V}$	Once each Polarity	0 / 22
12	Vibration test	-	a = 196m/s ² , f = 100~2KHz , t = 48min for all xyz axes	4 times	0 / 22

*: Refer to forward current vs. derating curve diagram

Criteria for Judging Damage

Items	Symbols	Conditions	Failure Criteria
luminous Intensity	lv	IF = 20 mA	Testing Min. Value <spec.min.value 0.5<="" td="" x=""></spec.min.value>
Forward Voltage	VF	IF = 20 mA	Testing Max. Value ≥Spec.Max.Value x 1.2
Reverse Current	IR	VR = Maximum Rated Reverse Voltage	Testing Max. Value ≥Spec.Max.Value x 2.5
High temp. storage test	-	_	Occurrence of notable decoloration, deformation and cracking